

# LIST OF REFERENCES CITED BY APPLICANT (Use several sheets if necessary)

ATTY DOCKET NO.

6750-130-999

APPLICATION NO

10/645,654

APPLICANT

Shevchuk *et al.*

FILING DATE

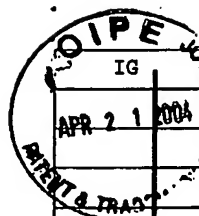
August 20, 2003

GROUP

2855

## U.S. PATENT DOCUMENTS

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
IG	A01	3,472,931	10/14/1969	Stoughton	424	180	
	A02	3,527,864	09/08/1970	MacMillan <i>et al.</i>	424	177	
	A03	3,896,238	07/22/1975	Smith	424	358	
	A04	3,903,256	09/02/1975	MacMillan <i>et al.</i>	424	59	
	A05	3,952,099	04/20/1976	Smith	424	227	
	A06	3,989,816	11/02/1976	Rajadhyaksha	424	60	
	A07	4,046,886	09/06/1977	Smith	424	227	
	A08	4,060,084	11/29/1977	Chandrasekaran <i>et al.</i>	128	260	
	A09	4,130,643	12/19/1978	Smith	424	238	
	A10	4,130,667	12/19/1978	Smith	424	361	
	A11	4,299,826	11/10/1981	Luedders	424	181	
	A12	4,316,893	02/23/1982	Rajadhyaksha	424	180	
	A13	4,335,115	06/15/1982	Thompson <i>et al.</i>	424	181	
	A14	4,343,798	08/10/1982	Fawzi	424	240	
	A15	4,379,454	04/12/1983	Campbell <i>et al.</i>	604	897	
	A16	4,405,616	09/20/1983	Rajadhyaksha	424	244	
	A17	4,560,553	12/24/1985	Zupan	424	78	
	A18	4,626,539	12/02/1986	Aungst <i>et al.</i>	514	282	
	A19	4,746,515	05/24/1988	Cheng <i>et al.</i>	424	449	
	A20	4,806,341	02/21/1989	Chien <i>et al.</i>	424	448	
	A21	4,863,952	09/05/1989	Abe <i>et al.</i>	514	423	
	A22	4,863,970	09/05/1989	Patel <i>et al.</i>	514	784	
	A23	4,879,275	11/07/1989	Minaskanian <i>et al.</i>	514	24	
	A24	4,940,586	07/10/1990	Cheng <i>et al.</i>	424	464	
	A25	4,960,771	10/02/1990	Rajadhyaksha	514	228.8	
	A26	4,973,468	11/27/1990	Chiang <i>et al.</i>	424	449	
	A27	5,066,648	11/19/1991	Alexander <i>et al.</i>	514	714	
	A28	5,069,909	12/03/1991	Sharma <i>et al.</i>	424	449	
	A29	5,149,538	09/22/1992	Granger <i>et al.</i>	424	449	
	A30	5,164,406	11/17/1992	Helman <i>et al.</i>	514	357	
	A31	5,227,169	07/13/1993	Heiber <i>et al.</i>	424	449	
	A32	5,229,130	07/20/1993	Sharma <i>et al.</i>	424	449	
	A33	5,236,714	08/17/1993	Lee <i>et al.</i>	424	449	
	A34	5,238,933	08/24/1993	Catz <i>et al.</i>	514	236.2	
	A35	5,240,711	08/31/1993	Hille <i>et al.</i>	424	448	
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	A38	5,378,730	01/03/1995	Lee <i>et al.</i>	514	535	
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	A40	5,474,783	12/12/1995	Miranda <i>et al.</i>	424	448	
	A41	5,641,504	06/24/1997	Lee <i>et al.</i>	424	447	
	A42	5,716,638	02/10/1998	Touitou	424	450	
	A43	5,718,914	02/17/1998	Foldvari	424	450	
	A44	5,750,137	05/12/1998	Taskovich <i>et al.</i>	424	448	
	A45	5,785,991	07/28/1998	Burkoth <i>et al.</i>	424	448	
	A46	5,804,215	09/08/1998	Cubbage <i>et al.</i>	424	449	
	A47	5,830,497	11/03/1998	Yamanaka <i>et al.</i>	424	448	
	A48	5,834,468	11/10/1998	Breault <i>et al.</i> -	514	247	
	A49	5,837,289	11/17/1998	Grasela <i>et al.</i>	424	484	
	A50	5,882,676	03/16/1999	Lee <i>et al.</i>	424	449	
	A51	5,902,603	05/11/1999	Chen <i>et al.</i>	424	449	
	A52	5,912,009	06/15/1999	Venkateshwaran <i>et al.</i>	424	448	
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	A59						
	A60						

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	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO
	B01						
	B02						
	B03						
	B04						
	B05						

## OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, Etc.)

IG	C01	Idson, "Percutaneous Absorption," 1975 June, <i>J. Pharma. Sci.</i> 64(6):901-24
IG	C02	Tan <i>et al.</i> , "Pressure-sensitive adhesives for transderman drug delivery systems," 1999 Feb., <i>PSTT</i> 2(2):60-9
	C03	

EXAMINER /Isis Ghali/

DATE CONSIDERED 09/29/2006

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.